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| | |
|-------------|---|
| Structure | Silicon Monolithic Bipolar IC |
| Appearance | SIL-9 Pin Plastic Package (Power Type with Fin) |
| Application | Low Frequency Amplifier |
| Function | BTL 4.0W x 1ch Power Amplifier with Standby Function and Volume Function |

| A | Absolute Maximum Ratings | | | | |
|-----|---------------------------------|----------------|---|------------------|---------|
| No. | Item | Symbol | Ratings | Unit | Note |
| 1 | Storage Temperature | Tstg | -55 ~ +150 | °C | 1 |
| 2 | Operating Ambient Temperature | Topr | -25 ~ +70 | °C | 1 |
| 3 | Operating Ambient Pressure | Popr | 1.013x10 ⁵ ±0.61x10 ⁵ | Pa | |
| 4 | Operating Constant Acceleration | Gopr | 9,810 | m/s ² | |
| 5 | Operating Shock | Sopr | 4,900 | m/s ² | |
| 6 | Supply Voltage | Vcc | 14.4 | V | 2 |
| 7 | Supply Current | Icc | 1.0 | A | |
| 8 | Power Dissipation | P _D | 1.22 | W | Ta=70-C |

| | | |
|--------------------------------|-----|--------------|
| Operating Supply Voltage Range | Vcc | 3.5V ~ 13.5V |
|--------------------------------|-----|--------------|

Note 1) The temperature of all items shall be Ta=25°C except storage temperature and operating ambient temperature.

2) At no signal input.

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| B | | Electrical Characteristics (Unless otherwise specified, the ambient temperature is 25°C±2°C, Vcc=8.0V, frequency=1kHz and RL=8Ω.) | | | | | | | |
|----|---------------------------|---|--------------|---|--------|------|------|-------|------|
| No | Item | Symbol | Test Circuit | Conditions | Limits | | | Unit | Note |
| | | | | | min | typ | max | | |
| 1 | Quiescent Circuit Current | IcQ | 1 | Vin=0V, Vol=0V | - | 20 | 60 | mA | |
| 2 | Standby Current | ISTB | 1 | Vin=0V, Vol=0V | - | 1 | 10 | μA | |
| 3 | Output Noise Voltage | VNO | 1 | Rg=10kΩ, Vol=0V | - | 0.10 | 0.4 | mVrms | 1 |
| 4 | Voltage Gain | Gv | 1 | Po=0.5W, Vol=1.25V | 31 | 33 | 35 | dB | |
| 5 | Total Harmonic Distortion | THD | 1 | Po=0.5W, Vol=1.25V | - | 0.10 | 0.5 | % | |
| 6 | Maximum Power Output 1 | PO1 | 1 | THD=10%, Vol=1.25V | 2.4 | 3.0 | - | W | |
| 7 | Maximum Power Output 2 | PO2 | 1 | Vcc=9V THD=10%, Vol=1.25V | 3.2 | 4.0 | - | W | |
| 8 | Ripple Rejection Ratio | RR | 1 | Rg=10kΩ, Vol=0V Vr=0.5Vrms, fr=120Hz | 30 | 50 | - | dB | 1 |
| 9 | Output Offset Voltage | Voff | 1 | Rg=10kΩ, Vol=0V | -250 | 0 | 250 | mV | |
| 10 | Volume Attenuation Ratio | Att | 1 | Po=0.5W, Vol=0V | 70 | 85 | - | dB | 1 |
| 11 | Middle Voltage Gain | Gvm | 1 | Po=0.5W, Vol=0.6V | 20.5 | 23.5 | 26.5 | dB | |

Note 1) For this measurement, use the BPF = 15Hz ~ 30kHz (12dB/OCT).

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| B | | Electrical Characteristics | | (Unless otherwise specified, the ambient temperature is 25°C±2°C, V _{CC} =8.0V, frequency=1kHz and R _L =8Ω.) | | | | | |
|----|---------------------|----------------------------|--------------|--|--------|-----|-----|------|------|
| No | Item | Symbol | Test Circuit | Conditions | Limits | | | Unit | Note |
| | | | | | min | typ | max | | |
| 1 | Standby pin current | I _{STB2} | 1 | V _{in} =0V, V _{STB} =3V | - | - | 25 | μA | |
| 2 | Volume pin current | I _{VOL} | 1 | V _{in} =0V, V _{ol} =0V | -12 | - | - | μA | |
| 3 | Input Impedance | Z _i | 1 | V _{in} =±0.3VDC | 24 | 30 | 36 | kΩ | |

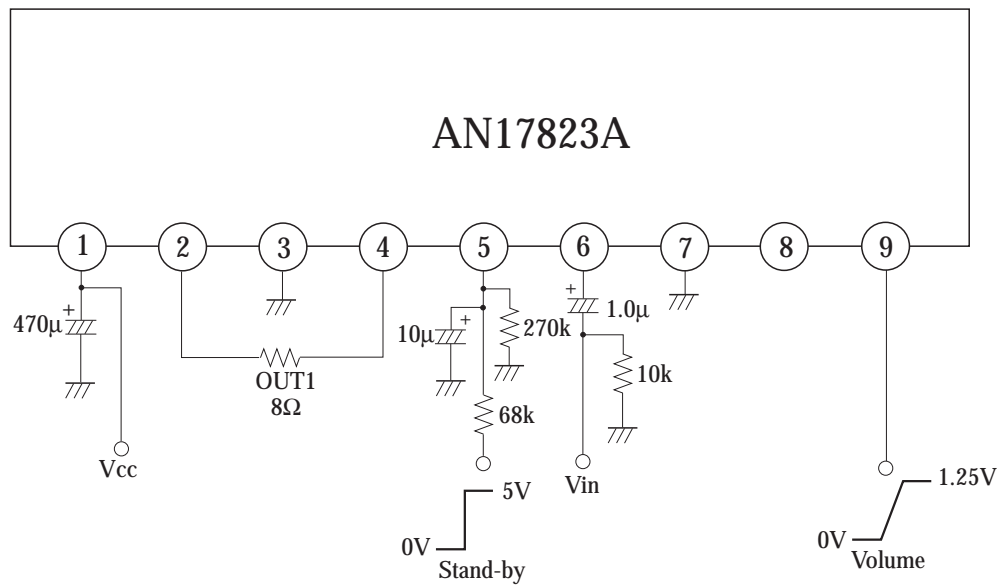
Note) The above characteristics are reference values determined for IC design, but not guaranteed values for shipping inspection. If problems were to occur, counter measures will be sincerely discussed.

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(Description of test circuit and test method)

Test Circuit 1

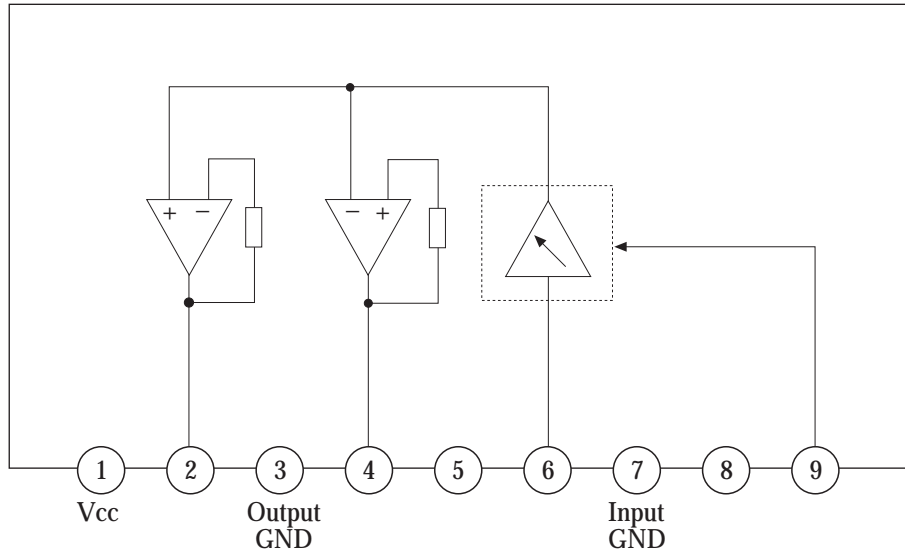


Note) If the standby pin is open or 0V, the IC is on standby state.
 The IC is in the state of volume minimum if the Volume pin is ground.
 The IC is in the state of volume maximum if the Volume pin is open.

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Circuit Function Block Diagram



Pin Descriptions

| Pin No. | Description |
|---------|---------------|
| 1 | Vcc |
| 2 | Ch Output (+) |
| 3 | GND (Output) |
| 4 | Ch Output (-) |
| 5 | Standby |
| 6 | Ch Input |
| 7 | GND (Input) |
| 8 | N.C |
| 9 | Volume |

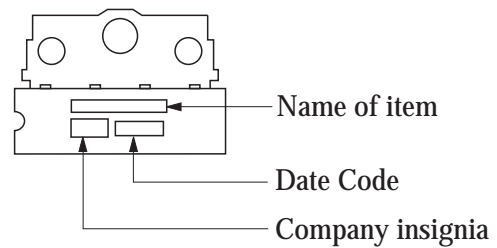
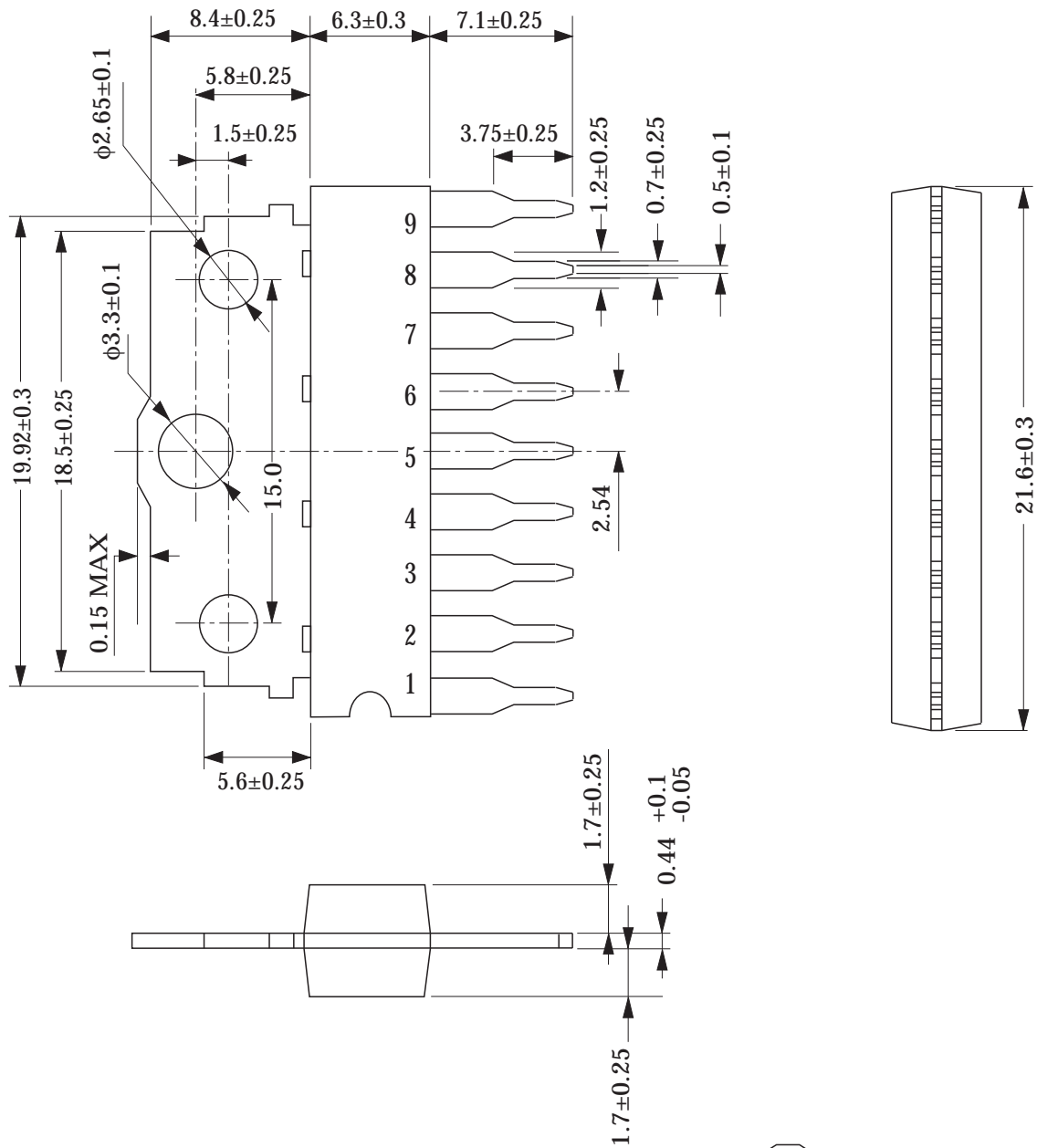
Note) Do not apply voltage or current to NC pin from outside.

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|--------------|--------|
| Package Name | F - 9S |
|--------------|--------|

Unit : mm



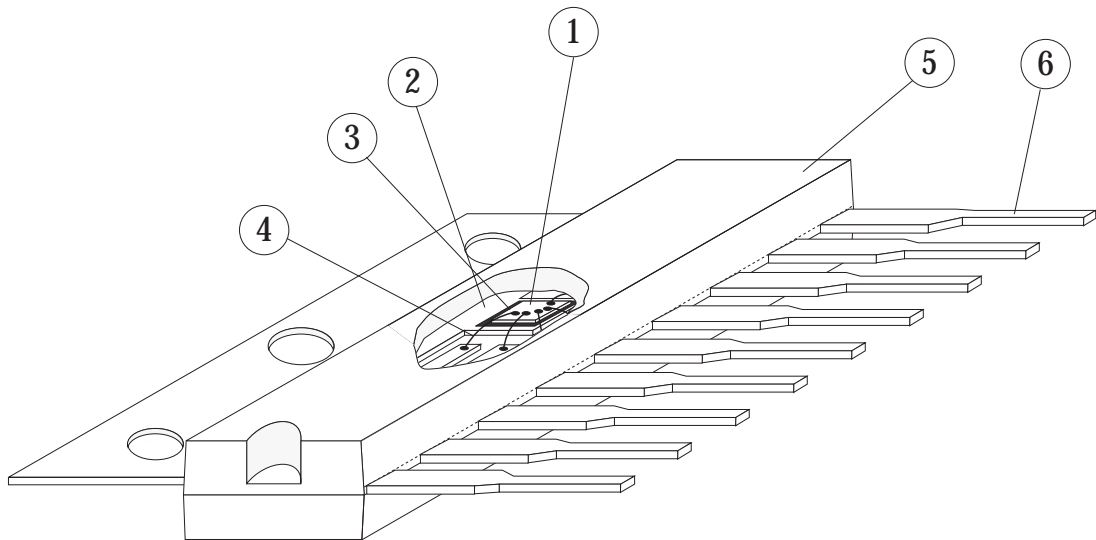
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(Structure Description)

| | | | | | |
|----------------------------|-----------------------|--------------------|------------|------------|---|
| Chip surface passivation | SiN, | PSG, | Others () | ① | |
| Lead frame material | Fe group, | Cu group, | Others () | ②, ⑥ | |
| Inner lead surface process | Ag plating, | Au plating, | Others () | ② | |
| Outer lead surface process | Solder plating, | Solder dip, | Others () | ⑥ | |
| Chip mounting method | Ag paste, | Au-Si alloy, | Solder, | Others () | ③ |
| Wire bonding method | Thermalsonic bonding, | | Others () | ④ | |
| Mold material | Epoxy, | | Others () | ⑤ | |
| Molding method | Transfer mold, | Multiplunger mold, | Others () | ⑤ | |

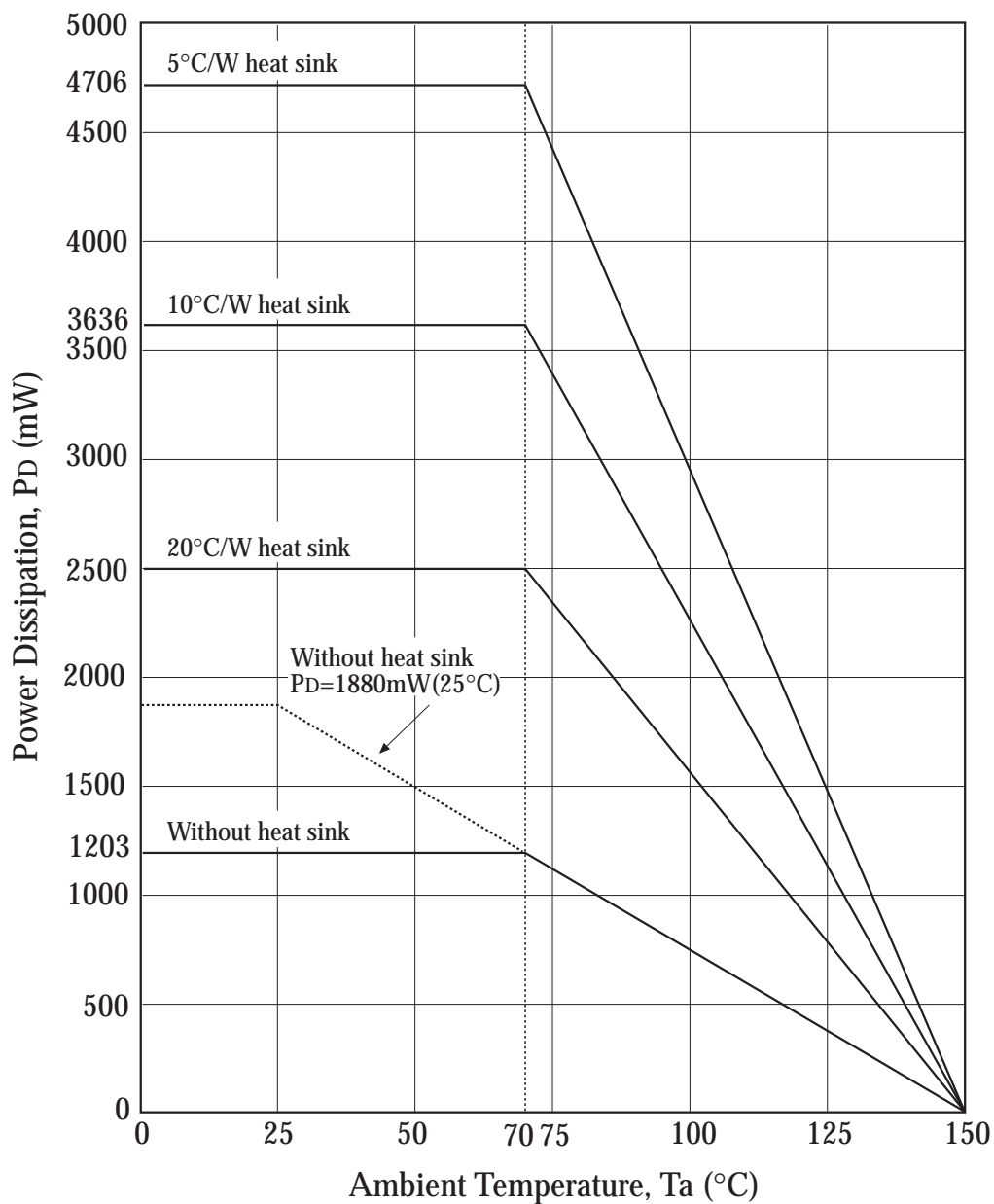
Package 9-SIP(F)



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$(R_{th(j-c)} = 12.0^{\circ}\text{C/W})$
 $(R_{th(j-a)} = 66.5^{\circ}\text{C/W})$
F-9S Package Power Dissipation
PD - Ta



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(Precautions for use)

- 1) Make sure that the IC is free of any pin short-circuiting, ground short, and load short-circuiting.
- 2) Ground the radiation fin so that there will be no difference in electric potential between the radiation fin and ground.
- 3) The thermal protection circuit operates at a Tj of approximately 150°C. The thermal protection circuit is reset automatically when the temperature drops.
- 4) Make sure that the heat radiation design is effective enough if the Vcc is comparatively high or the IC operates high output power.
- 5) Connect only ground pin for signal sources to the signal GND pin of the amplifier on the previous stage.

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